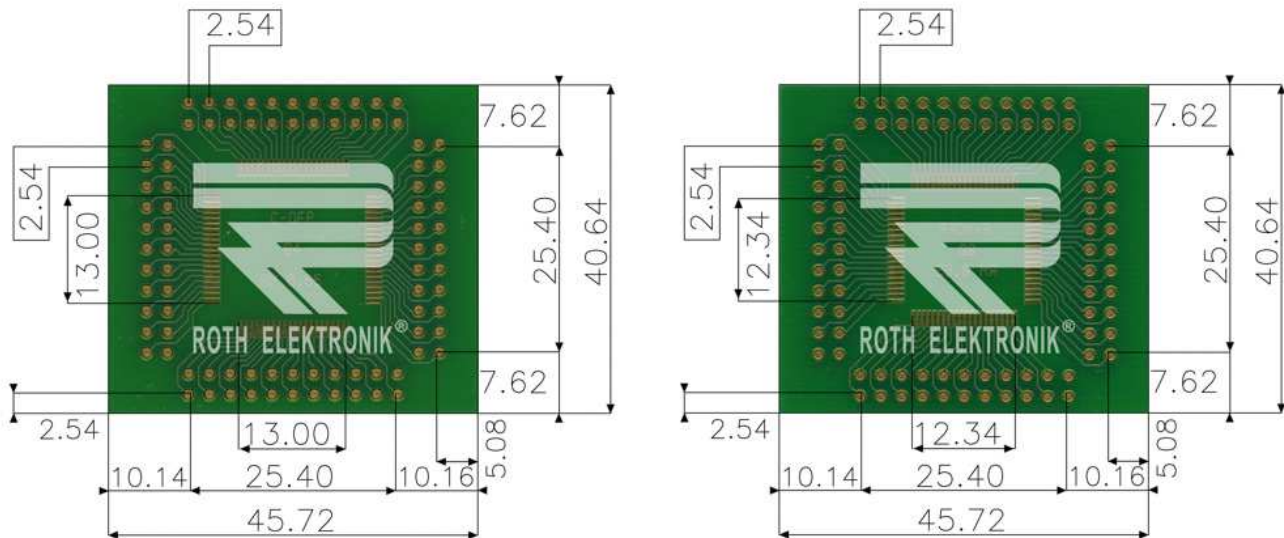
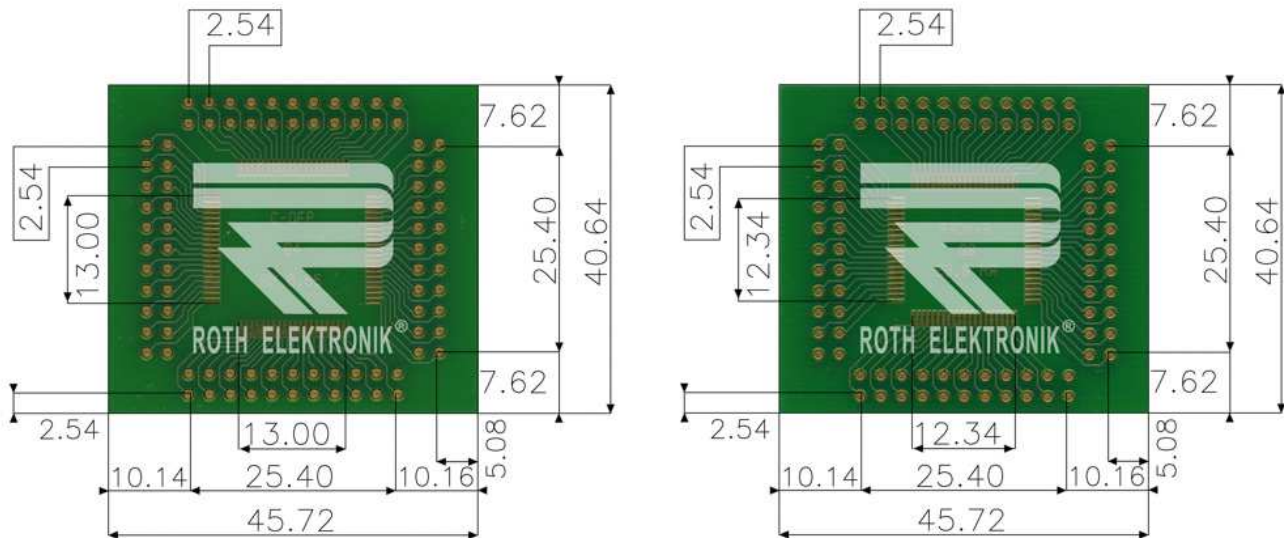




RE460-03

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au and solder stop mask
- Adaption circuit board for QFP 80,84 (0.65 mm)
- Hole diameter 1.00 mm
- Size 40.64 x 45.72 mm

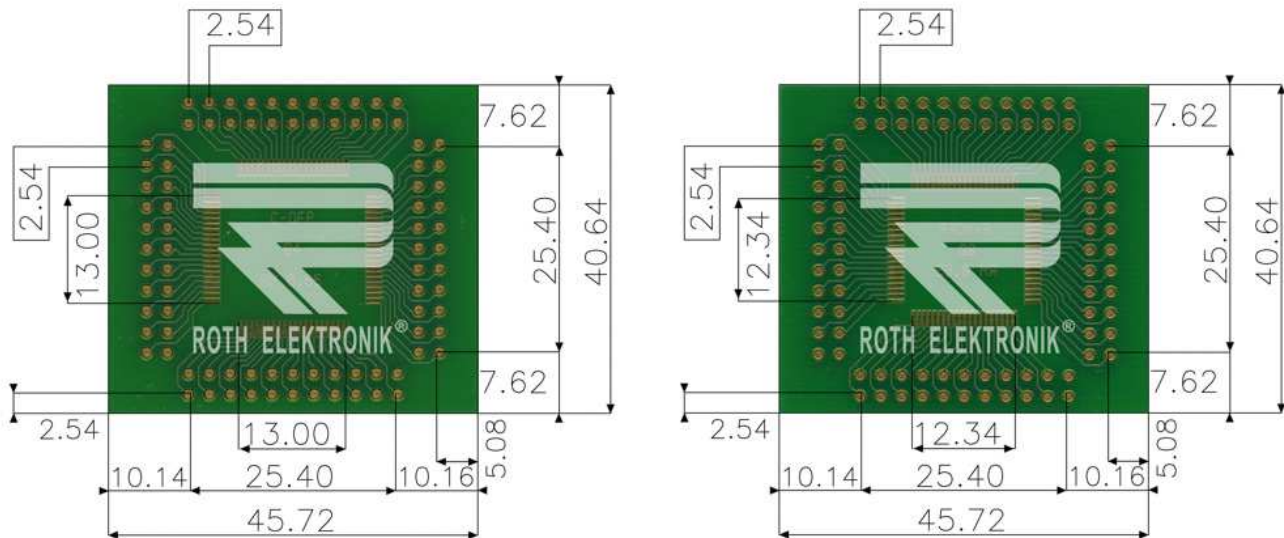
ver.20150130



RE460-03

- Epoxydglashartgewebe FR4 1,50 mm
- Zweiseitig 35 µm Cu
- Durchkontaktiert (PTH)
- Oberfläche chem. Ni/Au mit Lötstopplack beschichtet
- Adaption Platine für QFP 80, 84 (0,65 mm)
- Lochdurchmesser 1,00 mm
- Größe 40,64 x 45,72 mm

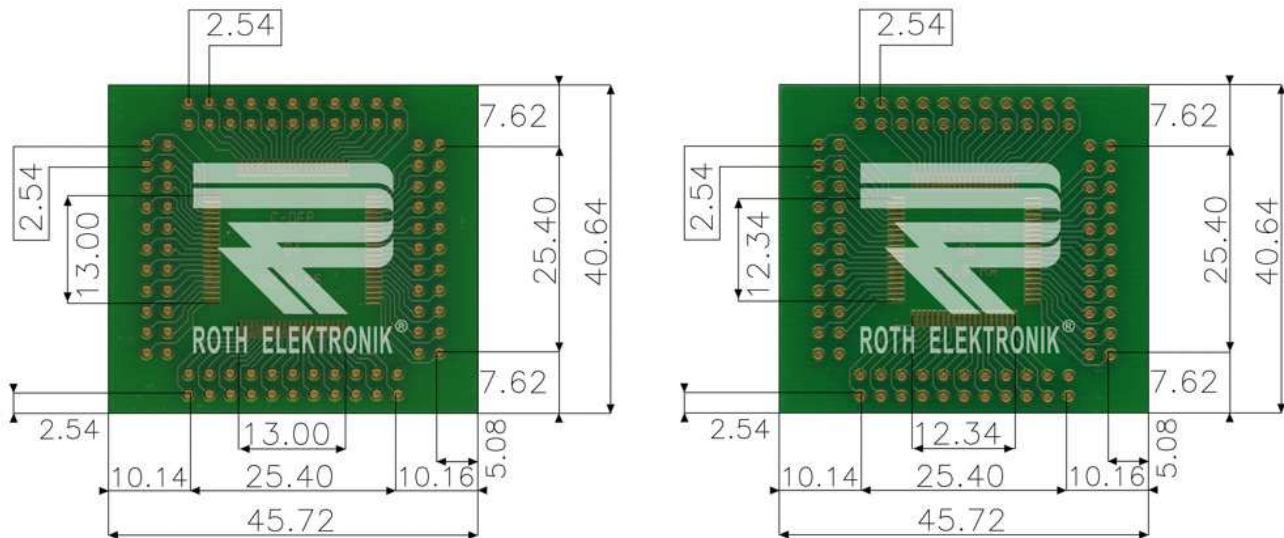
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RE460-03

- Fibre de verre époxyde FR4 1,50 mm
- Double face Cu 35 µm
- Métallisation des trous (PTH)
- Surface avec Ni/Au chimique et un laque d'arrêt de soudure
- Platine d'adaptation pour QFP 80, 84 (0,80 mm)
- Perforation 1,00 mm Ø
- Dimensions 40,64 x 45,72 mm

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RE460-03

- Fibra de vidrio epoxídica FR4 1,50 mm
- Por dos lados 35 µm de Cu
- Agujeros con contactos metalizados (PTH)
- Superficie terminal química de Ni/Au y una máscara de inhibidora de la soldadura
- Adaptador para QFP 80, 84 (0,65 mm)
- Diámetro de agujero 1,00 mm
- Tamaño 40,64 x 45,72 mm

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